

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Qing Ma

Title: DIRECT BUILD-UP LAYER ON AN ENCAPSULATED DIE PACKAGE HAVING A
MOISTURE BARRIER STRUCTURE

Docket No.: 884.803US2

Serial No.: 10/774,923

Filed: February 9, 2004

Duc Date: January 28, 2008

Examiner: Roy K. Potter

Group Art Unit: 2822

MS Amendment

Commissioner for Patents

P.O. Box 1450

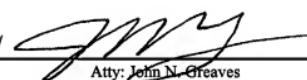
Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

X Amendment and Response Under 37 CFR 1.111 (7 pgs.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG & WOESSNER, P.A.
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By: 

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(GENERAL)